



## Material Content Data Sheet



<b>Sales Product Name</b>		IPS65R650CE		<b>Issued</b>		25. January 2018		
<b>MA#</b>		MA001584888						
<b>Package</b>		PG-TO251-3-346		<b>Weight*</b>		386.28 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.294	0.85	0.85	8527	8527
leadframe	non noble metal	iron	7439-89-6	0.209	0.05		540	
	inorganic material	phosphorus	7723-14-0	0.063	0.02		162	
	non noble metal	copper	7440-50-8	208.238	53.91	53.98	539083	539785
wire	non noble metal	aluminium	7429-90-5	4.424	1.15	1.15	11453	11453
encapsulation	organic material	carbon black	1333-86-4	0.676	0.17		1749	
	plastics	epoxy resin	-	18.241	4.72		47223	
	inorganic material	silicondioxide	60676-86-0	116.203	30.08	34.97	300825	349797
leadfinish	non noble metal	tin	7440-31-5	7.055	1.83	1.83	18263	18263
solder	noble metal	silver	7440-22-4	0.074	0.02		192	
	non noble metal	tin	7440-31-5	0.059	0.02		154	
	non noble metal	lead	7439-92-1	2.835	0.73	0.77	7340	7686
heatspreader	non noble metal	iron	7439-89-6	0.025	0.01		64	
	inorganic material	phosphorus	7723-14-0	0.007	0.00		19	
	non noble metal	copper	7440-50-8	24.879	6.44	6.45	64406	64489
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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